

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
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Hiromasa SATO	01/14/2011
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13126515
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Total Attachments: 1 source=1609_Assignment#page1.tif	

OP \$40.00 13126515

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me or us citizen(s) of Japan by JAPAN AE POWER SYSTEMS CORPORATION, a corporation organized under the laws of Japan, located at 8-3, Nishi-Shinbashi 3-chome, Minato-ku, Tokyo 105-0003, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said JAPAN AE POWER SYSTEMS CORPORATION, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

ELECTRODE MATERIAL FOR VACUUM CIRCUIT BREAKER AND METHOD OF MANUFACTURING THE SAME

invented by me or us and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said JAPAN AE POWER SYSTEMS CORPORATION, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said JAPAN AE POWER SYSTEMS CORPORATION.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

(発明者フルネームサイン)

Date Signed

(署名日)

1) Yasushi NODA



2011. 1. 6

2) Hiromasa SATO



2011. 1. 14

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